## SiR1309DP

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Vishay Siliconix

**RoHS** COMPLIANT

HALOGEN

FREE



 $\begin{tabular}{|c|c|c|c|} \hline PRODUCT SUMMARY \\ \hline V_{DS} (V) & -30 \\ \hline R_{DS(on)} \max. (\Omega) \mbox{ at } V_{GS} = -10 \ V & 0.0073 \\ \hline R_{DS(on)} \max. (\Omega) \mbox{ at } V_{GS} = -4.5 \ V & 0.0130 \\ \hline Q_g \ typ. (nC) & 28 \\ \hline I_D (A) & -65.7 \\ \hline Configuration & Single \\ \hline \end{tabular}$ 

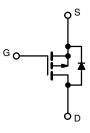
#### FEATURES

P-Channel 30 V (D-S) MOSFET

- TrenchFET<sup>®</sup> Gen IV p-channel power MOSFET
- 100 %  $R_{q}$  and UIS tested
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

#### APPLICATIONS

- Adapter switch
- Load switch
- Motor drive control
- Battery management
- Motor drive control



P-Channel MOSFET

ORDERING INFORMATION			
Package	PowerPAK SO-8		
Lead (Pb)-free and halogen-free	SIR1309DP-T1-GE3		

<b>ABSOLUTE MAXIMUM RATINGS</b> ( $T_A = 25 \text{ °C}$ , unless otherwise noted)					
PARAMETER		SYMBOL	LIMIT	UNIT	
Drain-source voltage		V <sub>DS</sub>	-30	V	
Gate-source voltage		V <sub>GS</sub>	± 25	v	
Continuous drain current (T <sub>J</sub> = 150 °C)	T <sub>C</sub> = 25 °C		-65.7		
	T <sub>C</sub> = 70 °C	Ι. Γ	-52.6		
	T <sub>A</sub> = 25 °C		-19.1 <sup>a, b</sup>		
	T <sub>A</sub> = 70 °C	1	-15.3 <sup>a, b</sup>	•	
Pulsed drain current (t = 100 µs)		I <sub>DM</sub>	-150	— A	
Continuous source-drain diode current	T <sub>C</sub> = 25 °C		-51.6		
	T <sub>A</sub> = 25 °C	I <sub>S</sub>	-4.3 <sup>a, b</sup>		
Single pulse avalanche current		I <sub>AS</sub>	-20		
Single pulse avalanche energy	L = 0.1 mH	E <sub>AS</sub>	20	mJ	
Maximum power dissipation	T <sub>C</sub> = 25 °C		56.8		
	T <sub>C</sub> = 70 °C		36.3	14/	
	T <sub>A</sub> = 25 °C		4.8 <sup>a, b</sup>	W	
	T <sub>A</sub> = 70 °C	1 –	3.0 <sup>a, b</sup>		
Operating junction and storage temperature range		T <sub>J</sub> , T <sub>stg</sub>	-55 to +150	*0	
Soldering recommendations (peak temperature) <sup>c, d</sup>			260		

THERMAL RESISTANCE RATINGS						
PARAMETER		SYMBOL	TYPICAL	MAXIMUM	UNIT	
Maximum junction-to-ambient a, e	t ≤ 10 s	R <sub>thJA</sub>	22	26	°C/W	
Maximum junction-to-case (drain)	Steady state	R <sub>thJC</sub>	1.8	2.2	0/10	

#### Notes

a. Surface mounted on 1" x 1" FR4 board

b. t = 10 s

c. See solder profile (<u>www.vishay.com/doc?73257</u>). The PowerPAK SO-8 is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection

d. Rework conditions: Manual soldering with a soldering iron is not recommended for leadless components

e. Maximum under steady state conditions is 70 °C/W

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### SiR1309DP

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PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT	
Static					•	•	
Drain-source breakdown voltage	V <sub>DS</sub>	$V_{GS} = 0 \text{ V}, \text{ I}_{D} = -250 \mu\text{A}$	-30	-	-	V	
V <sub>DS</sub> temperature coefficient	$\Delta V_{DS}/T_{J}$	I <sub>D</sub> = -250 μA	-	-27	-		
V <sub>GS(th)</sub> temperature coefficient	$\Delta V_{GS(th)}/T_J$	I <sub>D</sub> = -250 μA	-	4.4	-	mV/°C	
Gate-source threshold voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_{D} = -250 \ \mu A$	-1	-	-2.5	V	
Gate-source leakage	I <sub>GSS</sub>	$V_{DS} = 0 V, V_{GS} = \pm 25 V$	-	-	100	nA	
Zero gate voltage drain current	I <sub>DSS</sub>	$V_{DS} = -30 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$	-	-	-1	μA	
		$V_{DS} = -30 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ T}_{J} = 70 ^{\circ}\text{C}$	-	-	-15		
On-state drain current <sup>a</sup>	I <sub>D(on)</sub>	$V_{DS} \ge -10$ V, $V_{GS} = -10$ V	-40	-	-	Α	
Drain-source on-state resistance <sup>a</sup>		V <sub>GS</sub> = -10 V, I <sub>D</sub> = -10 A	-	0.006	0.0073	Ω	
	R <sub>DS(on)</sub>	V <sub>GS</sub> = -4.5 V, I <sub>D</sub> = -10 A	-	0.0102	0.0130		
Forward transconductance <sup>a</sup>	g <sub>fs</sub>	V <sub>DS</sub> = -10 V, I <sub>D</sub> = -10 A	-	37	-	S	
Dynamic <sup>b</sup>					•		
Input capacitance	C <sub>iss</sub>		-	3250	-	pF	
Output capacitance	C <sub>oss</sub>	V <sub>DS</sub> = -15 V, V <sub>GS</sub> = 0 V, f = 1 MHz	-	410	-		
Reverse transfer capacitance	C <sub>rss</sub>		-	375	-		
·		$V_{DS} = -15 \text{ V}, \text{ V}_{GS} = -10 \text{ V}, \text{ I}_{D} = -10 \text{ A}$	-	58	87	nC	
Total gate charge	Qg		-	28	42		
Gate-source charge	Q <sub>qs</sub>	V <sub>DS</sub> = -15 V, V <sub>GS</sub> = -4.5 V, I <sub>D</sub> = -10 A	-	10.7	-		
Gate-drain charge	Q <sub>ad</sub>		-	9.9	-		
Gate resistance	R <sub>q</sub>	f = 1 MHz	1.1	2.2	3.8	Ω	
Turn-on delay time	t <sub>d(on)</sub>		-	12	24	-	
Rise time	t <sub>r</sub>	$V_{DD} = -15 \text{ V}, \text{ R}_{L} = 1.5 \Omega, \text{ I}_{D} \cong -10 \text{ A},$	-	7	14		
Turn-off delay time	t <sub>d(off)</sub>	$V_{\text{GEN}} = -10 \text{ V}, \text{ R}_{\text{g}} = 1 \Omega$	-	40	80		
Fall time	t <sub>f</sub>		-	8	16		
Turn-on delay time	t <sub>d(on)</sub>		-	26	54	- ns -	
Rise time	t <sub>r</sub>	$V_{DD}$ = -15 V, R <sub>L</sub> = 1.5 Ω, I <sub>D</sub> ≅ -10 A, V <sub>GEN</sub> = -4.5 V, R <sub>g</sub> = 1 Ω	-	67	135		
Turn-off delay time	t <sub>d(off)</sub>		-	30	60		
Fall time	t <sub>f</sub>		-	20	40		
Drain-Source Body Diode Characteristi	cs					1	
Continuous source-drain diode current	Is	T <sub>C</sub> = 25 °C	-	-	-51.6		
Pulse diode forward current	I <sub>SM</sub>		-	-	-150	A	
Body diode voltage	V <sub>SD</sub>	I <sub>S</sub> = -5 A, V <sub>GS</sub> = 0 V	-	-0.75	-1.1	V	
Body diode reverse recovery time	t <sub>rr</sub>		- 1	18	36	ns	
Body diode reverse recovery charge	Q <sub>rr</sub>	I <sub>F</sub> = -10 A, di/dt = 100 A/μs,	-	8	16	nC	
Reverse recovery fall time	t <sub>a</sub>	$T_{\rm J} = 25 ^{\circ}{\rm C}$	-	9	-	ns	
Reverse recovery rise time	t <sub>b</sub>		-	9	-		

Notes

a. Pulse test; pulse width  $\leq$  300 µs, duty cycle  $\leq$  2 %

b. Guaranteed by design, not subject to production testing

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

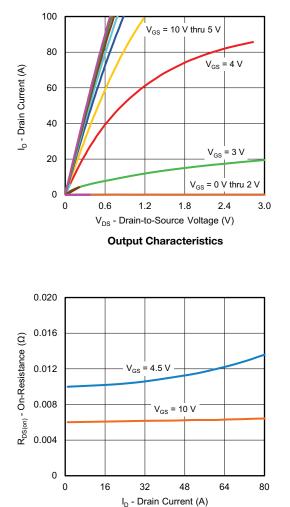
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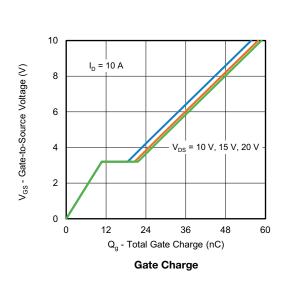
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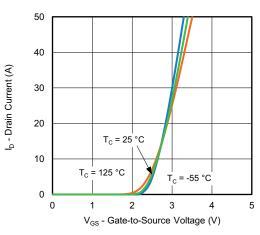
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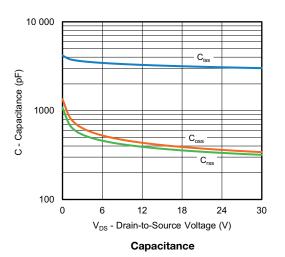


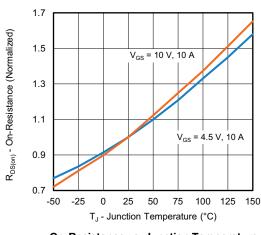
**On-Resistance vs. Drain Current and Gate Voltage** 





**Transfer Characteristics** 





**On-Resistance vs. Junction Temperature** 

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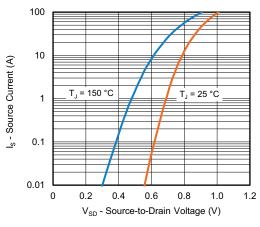
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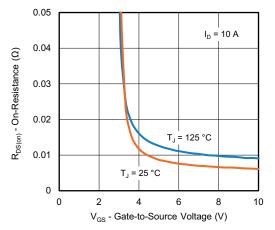


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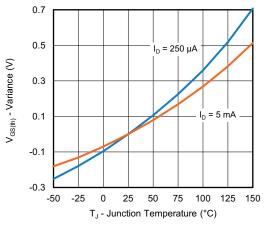
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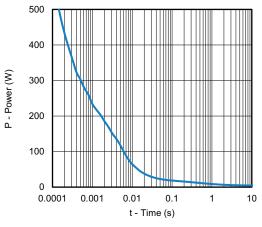
Source-Drain Diode Forward Voltage



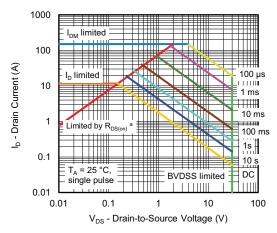
On-Resistance vs. Gate-to-Source Voltage



Threshold Voltage



Single Pulse Power, Junction-to-Ambient



Safe Operating Area, Junction-to-Ambient

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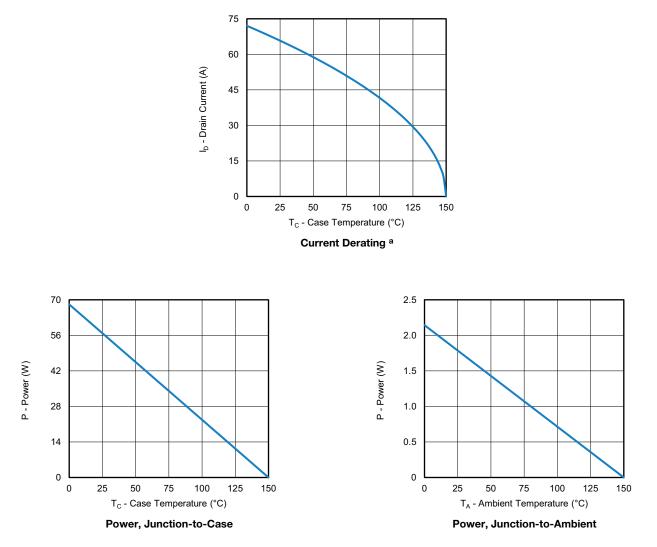
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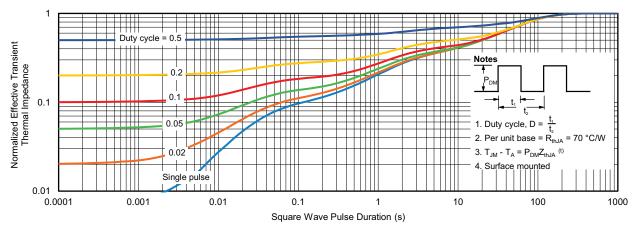
#### Note

a. The power dissipation P<sub>D</sub> is based on T<sub>J</sub> max. = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit

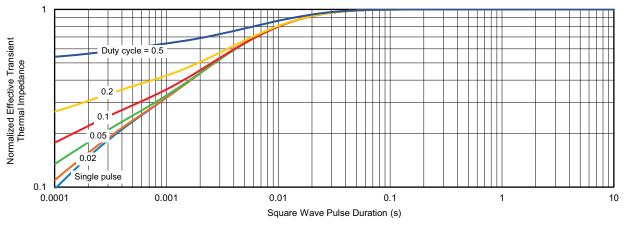


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#### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Case

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